

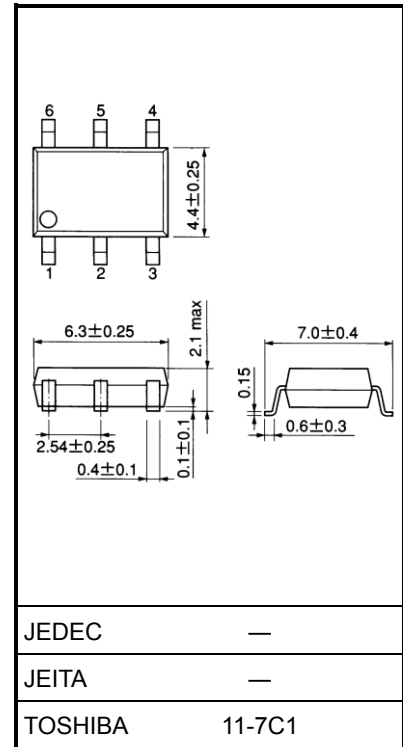
TLP3102

Measurement Equipment
 FA (Factory Automation)
 Power Line Control
 Security Equipment

The Toshiba TLP3102 consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface-mount assembly. The TLP3102 features high ON-state current and low ON-state resistance, hence the TLP3102 is suitable to control a power line.

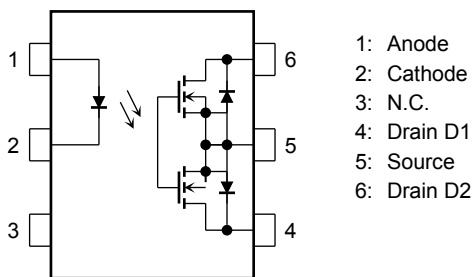
- 6-pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- Normally opened (form A) device
- Peak OFF-state voltage: 40 V (min)
- Trigger LED current: 3 mA (max)
- ON-state current: 2.5 A (max) ($T_a=50^\circ\text{C}$)
- ON-state resistance: 0.03 Ω (typ.), 0.06 Ω (max)
- Capacitance between output terminals: 1000 pF (typ.)
- OFF-state current: 10 nA (max)
- Isolation voltage: 1500 V_{rms} (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A
 File No.E67349

Unit: mm

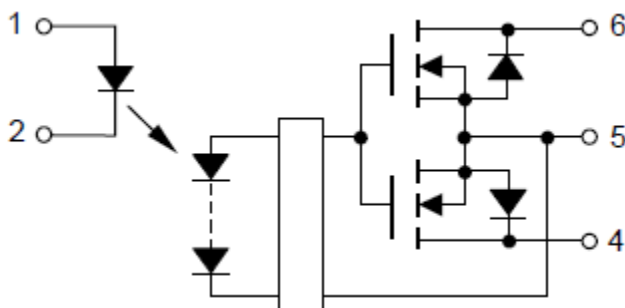


Weight: 0.13 g (typ.)

Pin Configuration (top view)



Schematic



Start of commercial production
 2010-06

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
LED	Forward current	IF	30	mA	
	Forward current derating (Ta ≥ 25°C)	ΔIF/°C	-0.3	mA/°C	
	Reverse voltage	VR	5	V	
	Diode power dissipation	PD	50	mW	
	Diode power dissipation derating (Ta ≥ 25°C)	ΔPD/°C	-0.5	mW/°C	
	Junction temperature	Tj	125	°C	
Detector	Off-state output terminal voltage	VOFF	40	V	
	On-state current	A connection	ION	2.5	A
		B connection		2.5	
		C connection		5.0	
	On-state current derating (Ta ≥ 50°C)	A connection	ΔION/°C	-33.3	mA/°C
		B connection		-33.3	
		C connection		-66.7	
	On-state Current (Pulsed) (t=100ms)	IONP	7.5	A	
	Output power dissipation	PO	406	mW	
	Output power dissipation derating (Ta ≥ 50°C)	ΔPO/°C	-5.42	mW/°C	
	Junction temperature	Tj	125	°C	
Storage temperature	Tstg	-55 to 125	°C		
Operating temperature	Topr	-40 to 85	°C		
Lead soldering temperature (10 s)	Tsol	260	°C		
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)	BVS	1500	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

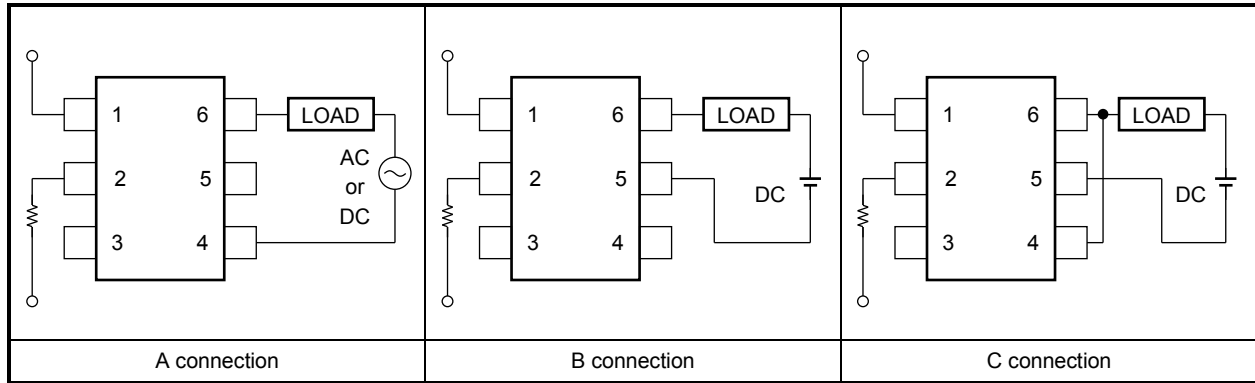
Note 1: Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	VDD	—	—	40	V
Forward current	IF	—	7.5	20	mA
Operating temperature	Topr	-20	—	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



Individual Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward current	V_F	$I_F = 10 \text{ mA}$	1.18	1.33	1.48	V
	Reverse current	I_R	$V_R = 5 \text{ V}$	—	—	10	μA
	Capacitance between terminals	C_T	$V_F = 0 \text{ V}, f = 1 \text{ MHz}$	—	70	—	pF
Detector	OFF-state current	I_{OFF}	$V_{OFF} = 40 \text{ V}$	—	—	10	nA
	Capacitance between terminals	C_{OFF}	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	1000	—	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current		I_{FT}	$I_{ON} = 100 \text{ mA}$	—	0.4	3	mA
Return LED current		I_{FC}	$I_{OFF} = 10 \mu\text{A}$	0.1	—	—	mA
On-state resistance	A connection	R_{ON}	$I_{ON} = 2.0 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	—	0.03	0.06	Ω
	B connection		$I_{ON} = 2.0 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	—	0.015	0.03	
	C connection		$I_{ON} = 4.0 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	—	0.008	—	

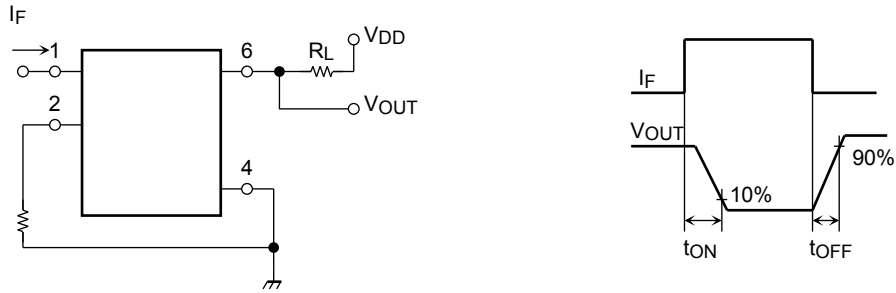
Isolation Characteristics (Ta = 25°C)

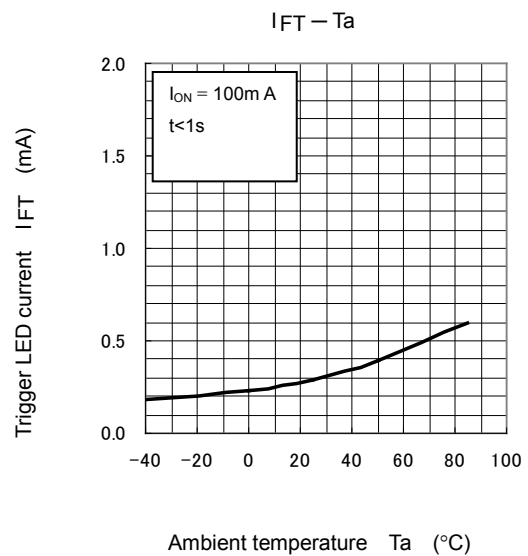
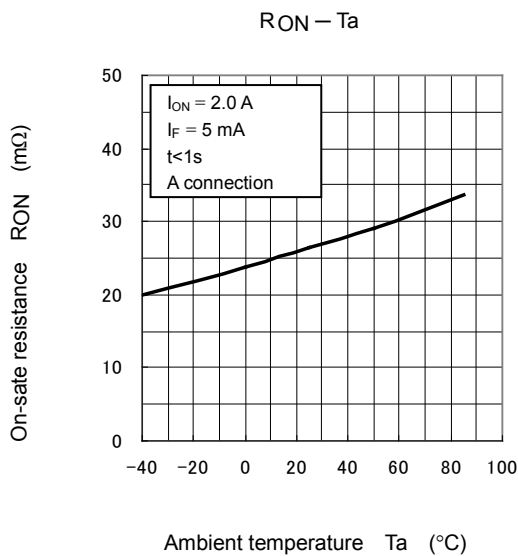
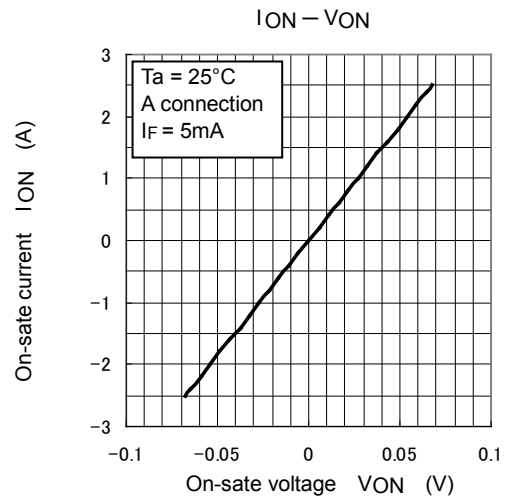
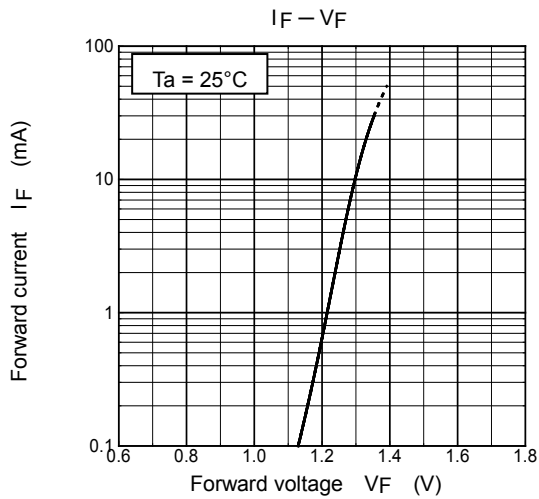
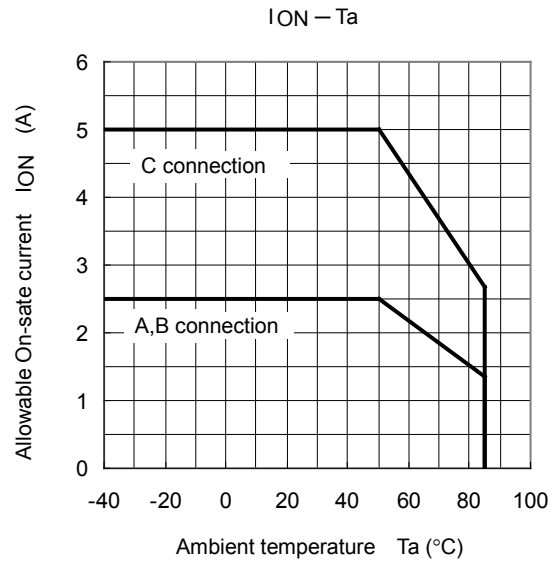
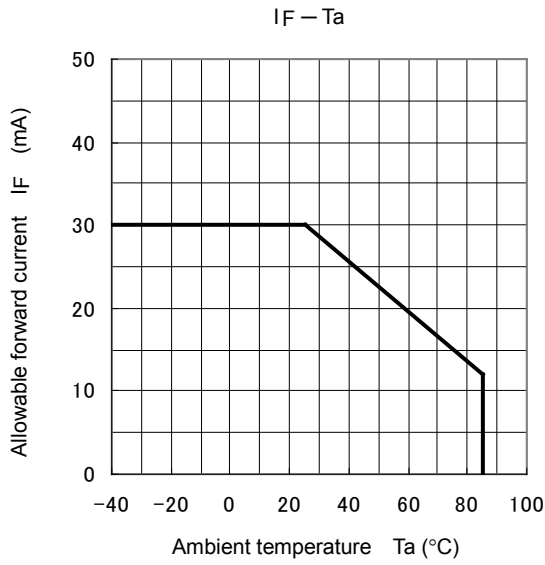
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, \text{R.H.} \leq 60 \%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	B_{VS}	AC, 60 s	1500	—	—	V_{rms}

Switching Characteristics (Ta = 25°C)

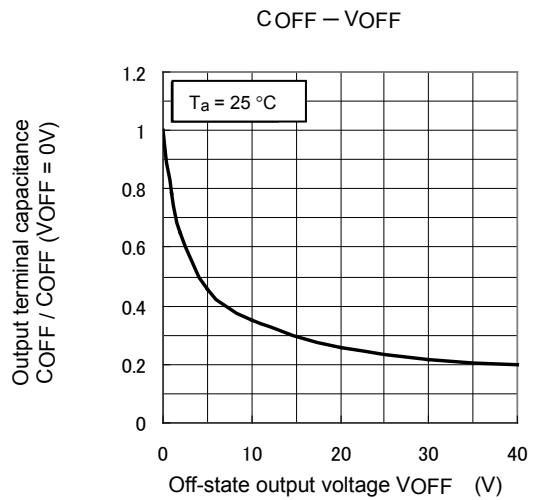
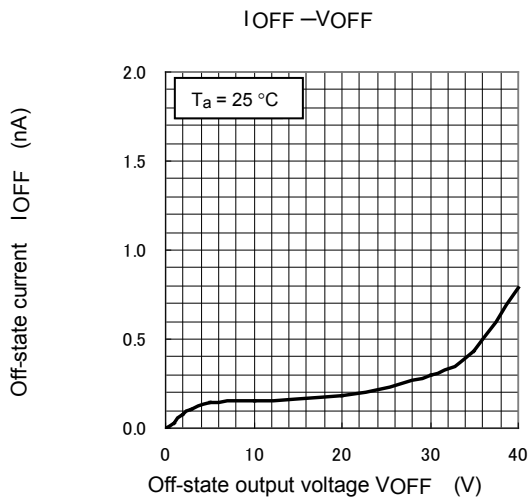
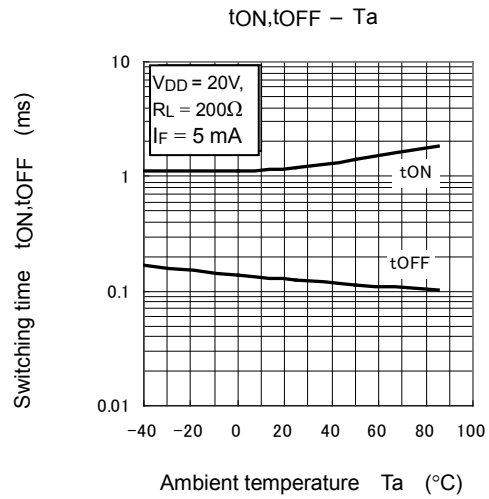
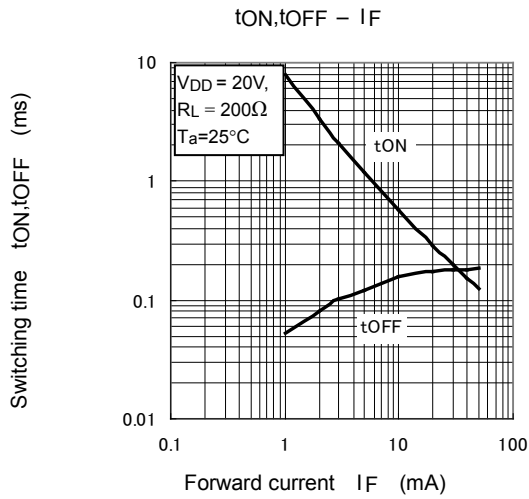
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-ON time	t _{ON}	R _L = 200 Ω V _{DD} = 20 V, I _F = 5 mA (Note 2)	—	1.0	5.0	ms
Turn-OFF time	t _{OFF}		—	0.15	1.0	
Turn-ON time	t _{ON}	R _L = 200 Ω V _{DD} = 20 V, I _F = 10 mA (Note 2)	—	0.5	3.0	
Turn-OFF time	t _{OFF}		—	0.15	1.0	

Note 2: Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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